

ME3110



High Efficiency, 18 V Input, 2 A, Sync BUCK DC-DC Converter

Description

ME3110 is a sync BUCK DC-DC converter IC, which integrates two NMOSFET power switches with low on-resistance. And R_{DSON} of high side and low side switches are $140m\Omega$ and $70m\Omega$ respectively. This product is capable of delivering 2A load current. In light load condition, ME3110 works in the PFM mode which has good efficiency performance. When load current goes heavy, ME3110 works in a quasi PWM mode. At this time, it has a constant switching frequency of 500 kHz.ME3110 incorporates OTP, input UVLO, cycle by cycle current limit protection and output short circuit protection to improve reliability.

Applications

- Set Top Box
- LCD TV
- DSL Modem
- Digital TV

Typical Application Circuit

C2 BOOT 3.3 uH VIN VOUT IN LX С3 ME3110 C4 C1 15 pF ΕN 2*22 uF 47 uF R2 22 kΩ **GND**

Features

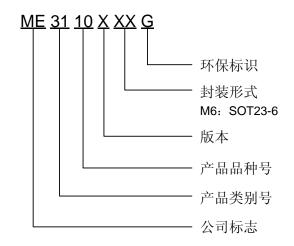
- Input Voltage Range: 4.4V ~ 18V
- Shutdown Current: 10uA
- Quiescent Current: 120uA
- $R_{DSON}(LSD/HSD)$: $70m\Omega/140m\Omega$
- Switching Frequency: 500kHz
- Reference Voltage: 0.6V ± 2%
- Cycle by Cycle Peak Current Limit: 5.5A
- Short Circuit Protection: Hiccup Mode
- Overtemperature Protection: 160°C

Package

• 6-pin SOT23-6

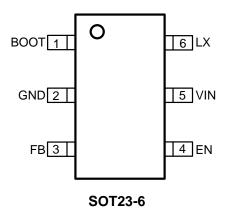


Selection Guide



产品型号	产品说明
ME3110AM6G	SOT23-6

Pin Configuration



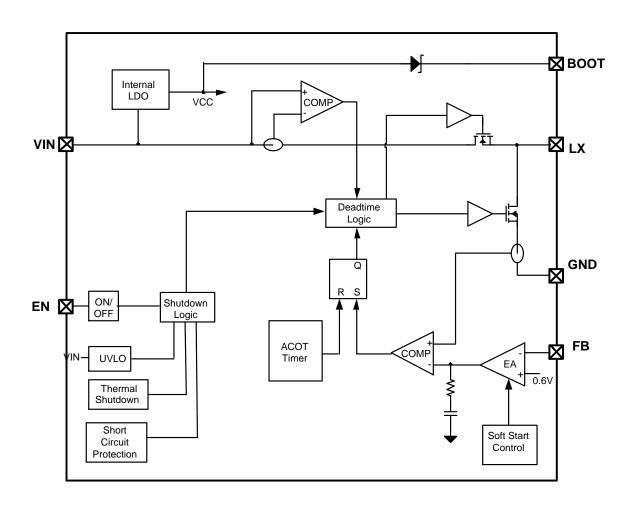
Pin Assignment

Pin Number	Pin name	Function		
1	воот	A ceramic capacitor more than 0.1 uF is needed between BOOT and LX. Power supply for driver of high side switch.		
2	GND	Ground pin.		
3	FB	Feedback voltage pin. Inverting input port of error amplifier.		
4	EN	Enable input pin. High logic enables the IC.		
5	VIN	Power input pin. Power supply for controller and switches.		
6	LX	Switch node and connecting inductor.		

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Block Diagram



Absolute Maximum Ratings

Parameter	Symbol	Ratings	Unit
VIN pin voltage range	V _{IN}	-0.3 ~ 18	V
LX pin voltage range	V _{LX}	-0.3 ~ 18	V
voltage between BOOT pin and SW pin	V _{BOOT_SW}	-0.3 ~ 6	V
EN pin voltage range	V _{EN}	-0.3 ~ 18	V
FB pin voltage range	V_{FB}	-0.3 ~ 18	V
Internal Power Dissipation	P _d	0.63	W
Thermal resistance (Junction to air)	θ_{JA}	200	°CM
Operating Temperature Range	T _A	-40 ~ +85	$^{\circ}$ C
Storage Temperature Range	T _{STG}	-55 ~ +150	$^{\circ}$
Maximum junction temperature	TJ	-40 ~ +150	$^{\circ}$ C

Attention: Stresses beyond those listed under **Absolute Maximum Ratings** may cause permanent damage to the device

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Recommended Operating Conditions

Symbol	Description	Min	Тур	Max	Unit
V _{IN}	Input voltage	4.4	12	18	V
V _{OUT}	Output voltage	0.6	3.3	-	V
L	Inductor value	1.2	3.3	6	uH
Соит	Output capacitor	30	40	-	uF
T _A	Operating ambient temperature	-40	-	85	°C

Electrical Characteristic

ME3110 test conditions: $V_{IN} = 12 \text{ V}$, $V_{OUT} = 3.3 \text{ V}$, $T_A = 25 ^{\circ}\text{C}$, unless otherwise noted.

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Input voltage range	V _{IN}		4.4	-	18	V
Shutdown current	I _{SD}	V _{IN} = 18 V, IC is enabled.	-	10	15	uA
Quiescent current	l _Q	$V_{IN} = 18 \text{ V}, V_{FB} = 0.66 \text{ V}, IC \text{ is}$ enabled	-	120	200	uA
Feedback reference voltage	V_{REF}		0.588	0.6	0.612	V
High side on-resistance	R _{DSON_H}	V_{BOOT} - V_{LX} = 4.5 V	-	140	200	mΩ
Low side on-resistance	R _{DSON_L}		-	70	100	mΩ
Peak current limit	I _{LIM_PEAK}		-	5.5	6.5	Α
Valley current limit	I _{LIM_VALLEY}		-	3	4	Α
EN rising threshold	V _{ENH}	V _{EN} rises.	-	1.3	1.5	V
EN falling threshold	V_{ENL}		0.8	1	-	V
Input UVLO threshold	V_{IN_UVLO}	V _{IN} falls	-	4.3	4.4	V
Input UVLO hysteresis	V _{IN_HYS}		-	0.25	-	V
Minimum on time	T_{min_on}		-	100	150	ns
Minimum off time	T_{min_off}		-	180	250	ns
Switching frequency	F _{SW}		-	500	-	kHz
Soft startup time	t _{ss}		-	2	-	ms
Over temperature protection	T _{OTP}		-	160	-	°C
Over temperature protection hysteresis	T _{HYS}		-	30	-	°C



Efficiency/%

50

40

0.001

0.01

Typical Performance Characteristics

Efficiency vs. IOUT

100
90
80
70
60

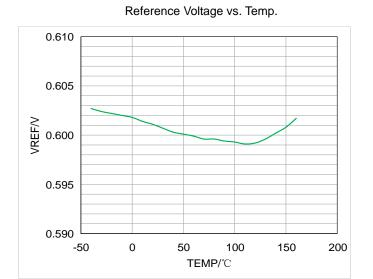
0.1

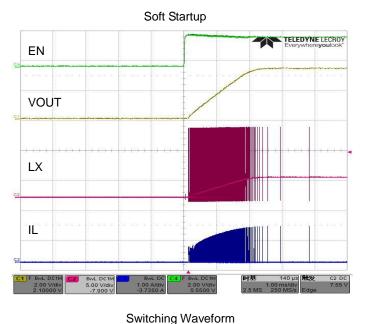
IOUT/A

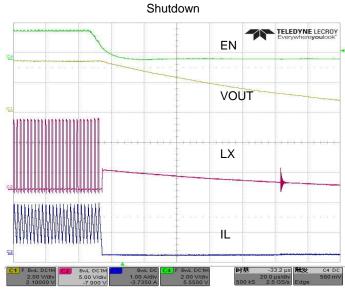
VIN=5V VIN=12V

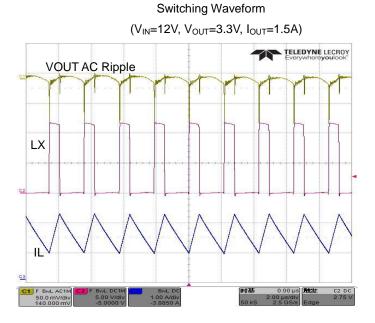
VIN=16V

1

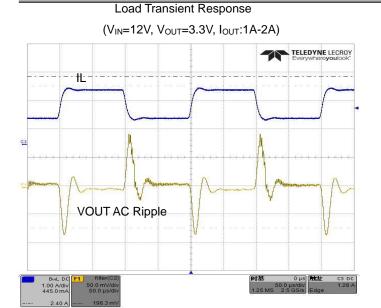












Short Circuit Protection and Recovery **TELEDYNELECROY Everywhereyoulook** LX LX

Operation

ME3110 is a highly efficient sync BUCK converter integrated circuits. It integrates two NMOSFET power switches of low on resistance. Power of driver of high side switch is supplied by bootstrap capacitor. The input voltage reaches up to 18 V. This converter can deliver 2A output current. ME3110 adopts constant on time architecture and has fast load transient response. In light load condition, it works in the PFM mode. In heavy load condition, it works in the quasi PWM mode.

Soft Startup

When the EN pin is pulled high, the blocks in the IC start to work in order. After the 0.6 V reference voltage settles down, a small current charges the soft startup capacitor. And the voltage of soft startup capacitor is used to control error amplifier. During the soft startup phase of about 2 ms, the soft startup voltage rises to 0.6 V gradually and V_{OUT} ramps up to the setting point accordingly. Soft startup can avoid large inrush current and V_{OUT} overshoot.

PFM Mode

When the load current decreases from heavy load, inductor current is reduced accordingly. And if the inductor valley current touches zero level, the device works in the DCM. Each switching period starts with charging inductor with constant time. Then the output voltage rises to a higher level. After the constant on time, the high side switch cuts off and the inductor current discharges to zero level. Because of the smaller load current, it takes longer time to discharge the output voltage to the reference level. And the switching frequency is reduced, proportional to the load current.

Shot Circuit Protection

When output is short to the ground, the device will shutdown for about 3.5ms. Then the chip can resume soft



startup automatically. After it maintains working for about 3ms, the device will stop from switching again. The device will repeat to shutdown and resume soft startup until the output short condition is released. Then output voltage will softly start up to the setting value..

Application Information

ME3110 can be used in applications in which power supply is converted from high level to low level. Because of the integrated power switches in IC, only input capacitor C_{IN} , output inductor L, output capacitor C_{OUT} and feedback resistors are selected for the desired application.

Setting Output Voltage

The output voltage can be set by selecting proper feedback resistors R1 and R2. To achieve good noise and power performance, it's recommended to using resistors between 10 k Ω and 1 M Ω . The resistor R1 can be calculated by the following equation.

$$R_1 = R_2 \times \left(\frac{V_{OUT}}{0.6V} - 1 \right)$$

Inductor Selection

To guarantee the normal work of the power system, the output inductor peak current should be below the peak current limit of 5.5 A. The inductor peak current can be calculated by the following equation. In consideration of magnetic saturation of inductor, the peak current should be also smaller than the saturate current of the inductor. And low DCR can help to meet desired power efficiency requirement.

$$I_{PEAK} = I_{OUT} + \frac{V_{OUT} \times (V_{IN} - V_{OUT})}{2 \times V_{IN} \times L} \times T$$

Bootstrap Capacitor

A 0.1 uF ceramic capacitor connected between the LX pin and the BOOT pin is required to supply power for the high side switch in applications based on ME3110.

Input Capacitor

In the BUCK converter system, severe interference exists between the VIN pin and ground. The input capacitor CIN can help to reduce interference and improve system stability. Because the effective capacitance can be reduced significantly at the DC biasing voltage, so the rated voltage of input capacitor should exceed the highest input voltage. And ME recommends the input capacitor should be placed as closely as possible to the VIN pin of the ME3110.

Output Capacitor

The step down DC-DC converter needs output filter capacitor. Small output capacitor may result in system instability. When output short circuit condition is released, the output voltage may overshoot the safe level, which can damage the following devices permanently.

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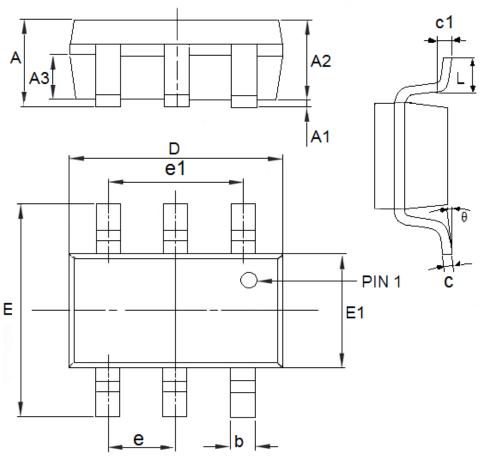
Layout Guidelines

- 1) BUCK converter implemented by ME3110 is sensitive to PCB layout. For reducing nonideality, external components such as inductor, input capacitor, output capacitor and resistor divider should be placed as nearly as possible to the chip.
- 2) For reducing EMI caused by high frequency switching, the trace connected to LX pin should be as short as possible. It is recommended to use ground plane to shield signal from interplane coupling.
- 3) To improve thermal dissipation and power efficiency, it is recommended to cover the back of PCB with ground plane. More thermal vias and thick PCB copper are desirable.



Package Information

Package Type: SOT23-6



DIM		neters	Inches		
DIM -	Min	Max	Min	Max	
А	1.05	1.45	0.0413	0.0571	
A1	0	0.15	0.0000	0.0059	
A2	0.9	1.3	0.0354	0.0512	
A3	0.55	0.75	0.0217	0.0295	
b	0.25	0.5	0.0098	0.0197	
С	0.1	0.25	0.0039	0.0098	
D	2.7	3.12	0.1063	0.1228	
e1	1.9(TYP)		0.0748(TYP)		
Е	2.6	3.1	0.1024	0.1220	
E1	1.4	1.8	0.0551	0.0709	
е	0.95(TYP)		0.0374	(TYP)	
L	0.25	0.6	0.0098	0.0236	
θ	0	8°	0.0000	8°	
c1	0.2(TYP)		0.0079	(TYP)	



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